

# MOS FIELD EFFECT TRANSISTOR 2SK2514

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

### **DESCRIPTION**

The 2SK2514 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

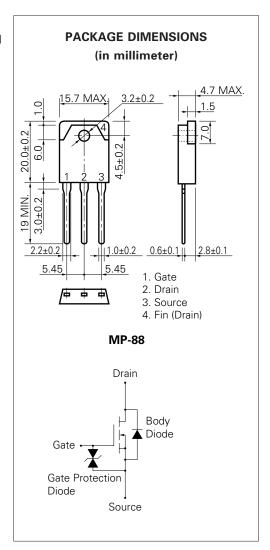
### **FEATURES**

- Super Low On-Resistance  $R_{DS \; (on)1} \leq 15 \; m\Omega \; (V_{GS} = 10 \; V, \; I_{D} = 25 \; A)$   $R_{DS \; (on)2} \leq 23 \; m\Omega \; (V_{GS} = 4 \; V, \; I_{D} = 25 \; A)$
- Low Ciss Ciss = 2 100 pF TYP.
- · Built-in G-S Protection Diode

### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID (DC)	±50	Α
Drain Current (pulse)*	ID (pulse)	±200	Α
Total Power Dissipation ( $T_c = 25$ °C)	P <sub>T1</sub>	150	W
Total Power Dissipation (T <sub>A</sub> = 25 °C)	P <sub>T2</sub>	3.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	T <sub>stg</sub> –	55 to +150	°C

\* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %





# ELECTRICAL CHARACTERISTICS (TA = 25 °C)

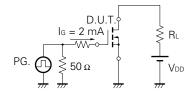
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS (on)1		11	15	mΩ	Vgs = 10 V, ID = 25 A
Drain to Source On-Resistance	RDS (on)2		16	23	mΩ	Vgs = 4 V, ID = 25 A
Gate to Source Cutoff Voltage	VGS (off)	1.0	1.5	2.0	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	l y <sub>fs</sub> l	15			S	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 25 A
Drain Leakage Current	IDSS			10	μΑ	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0
Gate to Source Leakage Current	Igss			±10	μΑ	$V_{GS} = \pm 20 \text{ V, } V_{DS} = 0$
Input Capacitance	Ciss		2 100		pF	V <sub>DS</sub> = 10 V
Output Capacitance	Coss		1 100		pF	V <sub>GS</sub> = 0
Reverse Transfer Capacitance	Crss		500		pF	f = 1 MHz
Turn-On Delay Time	td (on)		45		ns	ID = 25 A
Rise Time	tr		390		ns	VGS(on) = 10 V
Turn-Off Delay Time	td (off)		320		ns	V <sub>DD</sub> = 30 V
Fall Time	tf		360		ns	$R_G = 10 \Omega$
Total Gate Charge	Q <sub>G</sub>		92		nC	ID = 50 A
Gate to Source Charge	Qgs		6.0		nC	V <sub>DD</sub> = 48 V
Gate to Drain Charge	Q <sub>GD</sub>		37		nC	V <sub>GS</sub> = 10 V
Body Diode Forward Voltage	VF (S-D)		1.0		V	IF = 50 A, VGS = 0
Reverse Recovery Time	trr		90		ns	IF = 50 A, VGS = 0
Reverse Recovery Charge	Qrr		175		nC	di/dt = 100 A/μs

# **Test Circuit 1 Switching Time**

Duty Cycle ≤ 1 %

# PG. $\bigcap_{RG} R_G = 10 \Omega$ $V_{GS} \bigvee_{Wave Form} V_{GS} \bigvee_{V_{GS ten}} 90 \%$ $V_{GS} \bigvee_{Wave Form} V_{DD} \bigvee_{U_{DD}} V_{GS ten} \bigvee_{U_{$

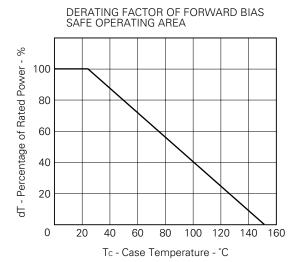
# Test Circuit 2 Gate Charge

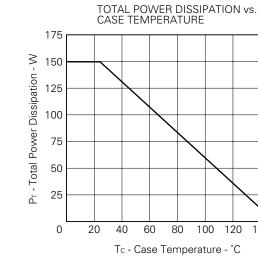


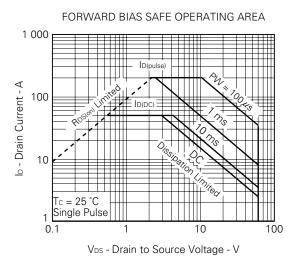
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

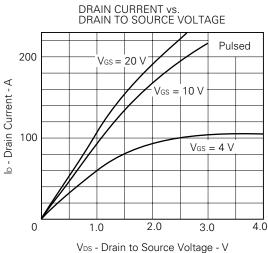
140 160

### TYPICAL CHARACTERISTICS (TA = 25 °C)

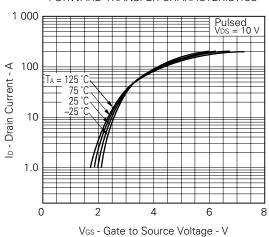






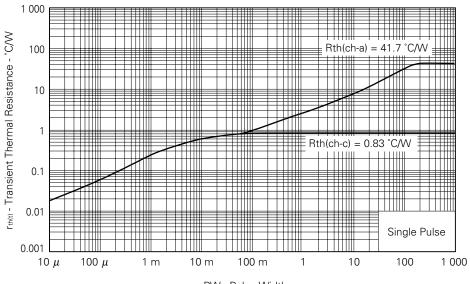


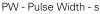




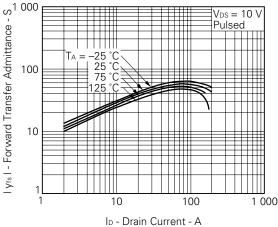


### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

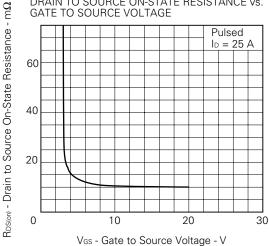






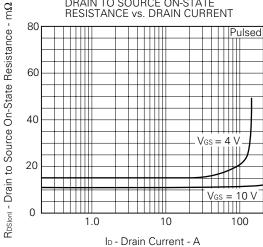


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

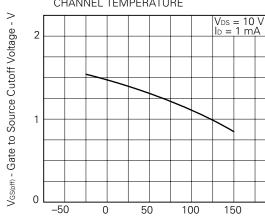




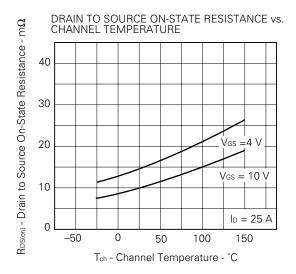


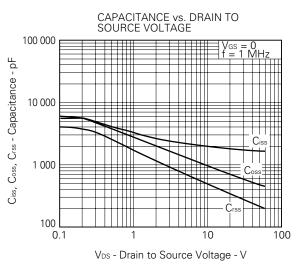


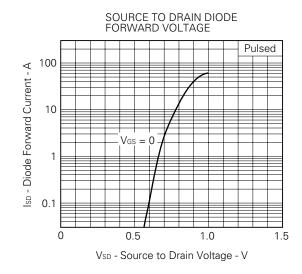
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

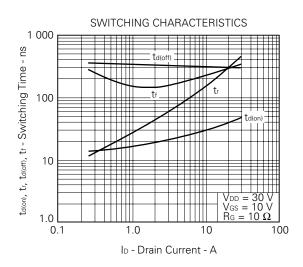


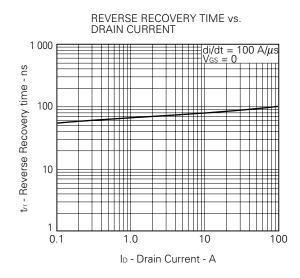
Tch - Channel Temperature - °C

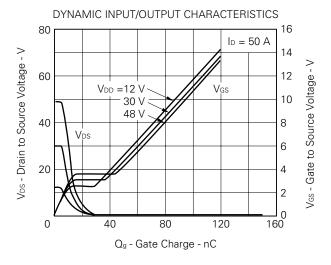














# **REFERENCE**

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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[MEMO]

### [MEMO]

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